

T-37-25

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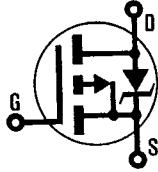
REPETITIVE AVALANCHE AND dv/dt RATED

HEXFET® TRANSISTORS **IRFR9010**

**IRFR9012**

**IRFU9010**

**IRFU9012**



P-CHANNEL

- 50 Volt, 0.50 Ohm HEXFET

The HEXFET® technology is the key to International Rectifier's advanced line of power MOSFET transistors. The efficient geometry and unique processing of this latest "State of the Art" design achieves: very low on-state resistance combined with high transconductance; superior reverse energy and diode recovery dv/dt capability.

The HEXFET transistors also feature all of the well established advantages of MOSFETs such as voltage control, very fast switching, ease of paralleling and temperature stability of the electrical parameters.

Surface mount packages enhance circuit performance by reducing stray inductances and capacitance. The D-Pak (TO-252AA) surface mount package brings the advantages of HEXFETs to high volume applications where PC Board surface mounting is desirable. The surface mount option IRFR9010 is provided on 16mm tape. The straight lead option IRFU9010 of the device is called the I-Pak (TO-251AA).

They are well suited for applications where limited heat dissipation is required such as, computers and peripherals, telecommunications equipment, DC/DC converters, and a wide range of consumer products.

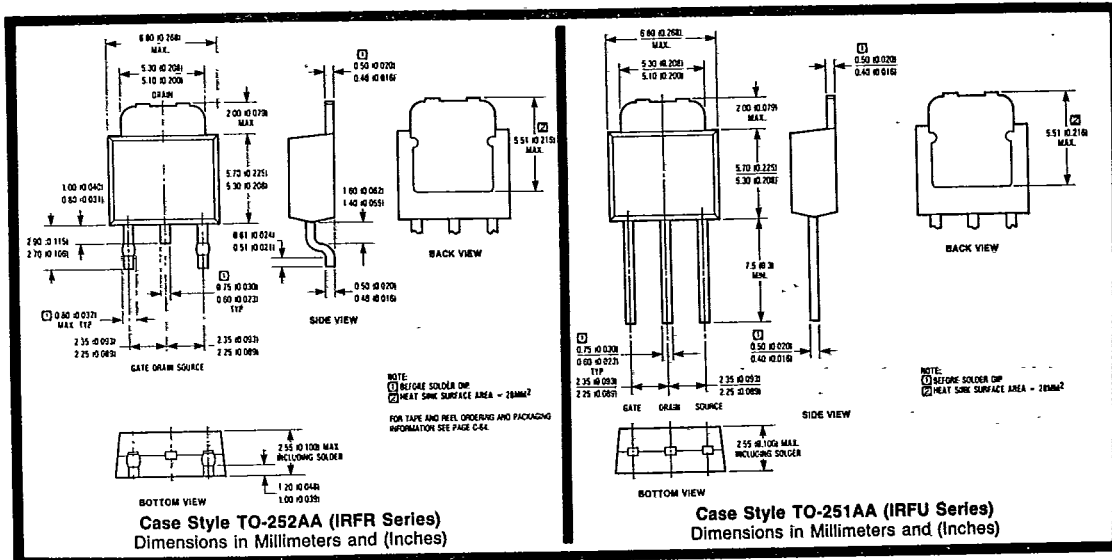
Product Summary

| Part Number | BVDSS | R <sub>DS(on)</sub> | I <sub>D</sub> |
|-------------|-------|---------------------|----------------|
| IRFR9010    | -50V  | 0.50Ω               | -5.3A          |
| IRFR9012    | -50V  | 0.70Ω               | -4.5A          |
| IRFU9010    | -50V  | 0.50Ω               | -5.3A          |
| IRFU9012    | -50V  | 0.70Ω               | -4.5A          |

D-PAK

FEATURES:

- Surface Mountable (Order As IRFR9010)
- Straight Lead Option (Order As IRFU9010)
- Repetitive Avalanche Ratings
- Dynamic dv/dt Rating
- Simple Drive Requirements
- Ease of Paralleling



IRFR9010, IRFR9012, IRFU9010, IRFU9012 Devices

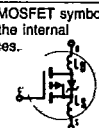
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Absolute Maximum Ratings


| Parameter  | IRFR9010, IRFU9010                        | IRFR9012, IRFU9012 | Units            |
|--|---|--------------------|------------------|
| $I_D @ T_C = 25^\circ\text{C}$ Continuous Drain Current          | -5.3                                      | -4.5               | A                |
| $I_D @ T_C = 100^\circ\text{C}$ Continuous Drain Current         | -3.3                                      | -2.8               | A                |
| $I_{DM}$ Pulsed Drain Current (1)                                | -21                                       | -18                | A                |
| $P_D @ T_C = 25^\circ\text{C}$ Max. Power Dissipation            | 25  |                    | W                |
| Linear Derating Factor   | 0.20                                      |                    | W/K (5)          |
| $V_{GS}$ Gate-to-Source Voltage                                  | $\pm 20$                                  |                    | V                |
| $E_{AS}$ Single Pulse Avalanche Energy (2)                       | 240<br>(See Fig. 14)                      |                    | mJ               |
| $I_{AR}$ Avalanche Current (1)<br>(Repetitive or Non-Repetitive) | -5.3<br>(See $E_{AR}$ )                   |                    | A                |
| $E_{AR}$ Repetitive Avalanche Energy (1)                         | 2.5<br>(See $I_{AR}$ )                    |                    | mJ               |
| $dv/dt$ Peak Diode recovery $dv/dt$ (3)                          | 5.8<br>(See Fig. 17)                      |                    | V/ns             |
| $T_J$ Operating Junction Temperature Range                       | -55 to 150                                |                    | $^\circ\text{C}$ |
| $T_{STG}$ Storage Temperature Range                              |   |                    | $^\circ\text{C}$ |
| Lead Temperature   | 300 (0.063 in. (1.6mm) from case for 10s) |                    | $^\circ\text{C}$ |

Electrical Characteristics @  $T_J = 25^\circ\text{C}$  (Unless Otherwise Specified)

| Parameter   | Type                 | Min. | Typ. | Max.  | Units | Test Conditions  |
|---|----------------------|------|------|-------|-------|--|
| $BV_{DSS}$ Drain-to-Source Breakdown Voltage                | All                  | -50  |      |       | V     | $V_{GS} = 0V, I_D = -250\mu\text{A}$   |
| $R_{DS(on)}$ Static Drain-to-Source On-State Resistance (4) | IRFR9010<br>IRFU9010 | —    | 0.35 | 0.50  | Ω     | $V_{GS} = -10V, I_D = -2.8A$   |
|   | IRFR9012<br>IRFU9012 | —    | 0.50 | 0.70  |       |  |
| $I_{D(on)}$ On-State Drain Current (4)                      | IRFR9010<br>IRFU9010 | -5.3 | —    | —     | A     | $V_{DS} > I_{D(on)} \times R_{DS(on)}$ Max.<br>$V_{GS} = -10V$   |
|   | IRFR9012<br>IRFU9012 | -4.5 | —    | —     |       |  |
| $V_{GS(th)}$ Gate Threshold Voltage                         | ALL                  | -2.0 | —    | -4.0  | V     | $V_{DS} = V_{GS}, I_D = -250\mu\text{A}$   |
| $g_{fs}$ Forward Transconductance (4)                       | ALL                  | 1.1  | 1.7  | —     | S(O)  | $V_{DS} \leq -50V, I_{DS} = -2.8A$   |
| $I_{DSS}$ Zero Gate Voltage Drain Current                   | ALL                  | —    | —    | -250  | μA    | $V_{DS} = \text{Max. Rating}, V_{GS} = 0V$<br>$V_{DS} = 0.8 \times \text{Max. Rating}$<br>$V_{GS} = 0V, T_J = 125^\circ\text{C}$ |
|   |                      | —    | —    | -1000 |       |  |
| $I_{GSS}$ Gate-to-Source Leakage Forward                    | ALL                  | —    | —    | -500  | nA    | $V_{GS} = -20V$  |
| $I_{GSS}$ Gate-to-Source Leakage Reverse                    | ALL                  | —    | —    | 500   | nA    | $V_{GS} = 20V$   |
| $Q_g$ Total Gate Charge                                     | ALL                  | —    | 6.1  | 9.1   | nC    | $V_{GS} = -10V, I_D = -4.7A$   |
| $Q_{gs}$ Gate-to-Source Charge                              | ALL                  | —    | 2.0  | 3.0   | nC    | $V_{DS} = 0.8 \times \text{Max. Rating}$<br>See Fig. 16  |
| $Q_{gd}$ Gate-to-Drain ("Miller") Charge                    |                      | —    | 3.9  | 5.9   | nC    | (Independent of operating temperature)   |
| $t_{d(on)}$ Turn-On Delay Time                              | ALL                  | —    | 6.1  | 9.2   | ns    | $V_{DD} = -25V, I_D = -4.7A, R_G = 24\Omega$   |
| $t_r$ Rise Time   | ALL                  | —    | 47   | 71    | ns    | $R_D = 5.6\Omega$  |
| $t_{d(off)}$ Turn-Off Delay Time                            | ALL                  | —    | 13   | 20    | ns    | See Fig. 15  |
| $t_f$ Fall Time   | ALL                  | —    | 35   | 59    | ns    | (Independent of operating temperature)   |
| $L_D$ Internal Drain Inductance                             | ALL                  | —    | 4.5  | —     | nH    | Measured from the drain lead, 6mm (0.25 in.) from package to center of die.  |
| $L_S$ Internal Source Inductance                            | ALL                  | —    | 7.5  | —     | nH    | Measured from the source lead, 6mm (0.25 in.) from package to source bonding pad.  |
| $C_{iss}$ Input Capacitance                                 | ALL                  | —    | 240  | —     | pF    | $V_{GS} = 0V, V_{DS} = -25V$   |
| $C_{oss}$ Output Capacitance                                | ALL                  | —    | 160  | —     | pF    | $f = 1.0 \text{ MHz}$  |
| $C_{rss}$ Reverse Transfer Capacitance                      | ALL                  | —    | 30   | —     | pF    | See Fig. 10  |



Source-Drain Diode Ratings and Characteristics

| Parameter                                     | Type | Min.   | Typ. | Max. | Units         | Test Conditions   |
|---|------|--|------|------|---------------|---|
| $I_S$ Continuous Source Current (Body Diode)  | ALL  | —  | —    | -5.3 | A             | Modified MOSFET symbol showing the integral Reverse p-n junction rectifier.  |
| $I_{SM}$ Pulsed Source Current (Body Diode) ① | ALL  | —  | —    | -18  | A             |   |
| $V_{SD}$ Diode Forward Voltage ④              | ALL  | —  | —    | -5.5 | V             | $T_J = 25^\circ\text{C}$ , $I_S = -5.3\text{A}$ , $V_{GS} = 0\text{V}$  |
| $t_{rr}$ Reverse Recovery Time                | ALL  | 33   | 75   | 160  | ns            | $T_J = 25^\circ\text{C}$ , $I_F = -4.7\text{A}$ , $di/dt = 100\text{ A}/\mu\text{s}$  |
| $Q_{RR}$ Reverse Recovery Charge              | ALL  | 0.090  | 0.22 | 0.52 | $\mu\text{C}$ |   |
| $t_{on}$ Forward Turn-On Time                 | ALL  | Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by $L_S + L_D$ . |      |      |               |   |

Thermal Resistance

|                                |     |   |     |     |       |                        |
|--------------------------------|-----|---|-----|-----|-------|------------------------|
| $R_{thJC}$ Junction-to-Case    | ALL | — | —   | 5.0 | K/W ⑤ |                        |
| $R_{thCS}$ Case-to-Sink        | ALL | — | 1.7 | —   | K/W ⑤ | Typical solder mount ⑥ |
| $R_{thJA}$ Junction-to-Ambient | ALL | — | —   | 110 | K/W ⑤ | Typical socket mount   |



- ① Repetitive Rating; Pulse width limited by maximum junction temperature (see figure 5)
- ② @  $V_{DD} = -25\text{V}$ , Starting  $T_J = 25^\circ\text{C}$ ,  $L = 9.7\text{ mH}$ ,  $R_G = 25\Omega$ , Peak  $I_L = -5.3\text{A}$
- ③  $I_{SD} \leq -5.3\text{A}$ ,  $di/dt \leq -80\text{ A}/\mu\text{s}$ ,  $V_{DD} 40\text{V}$ ,  $T_J \leq 150^\circ\text{C}$ , Suggested  $R_G = 24\Omega$
- ④ Pulse width  $\leq 300\ \mu\text{s}$ ; Duty Cycle  $\leq 2\%$
- ⑤  $K/W = \text{ }^\circ\text{C}/W$   
 $W/K = W/^\circ\text{C}$
- ⑥ Mounting pad must cover heatsink surface area. See case style drawing on front page

The information shown on the following graphs applies also to the IRFU devices.

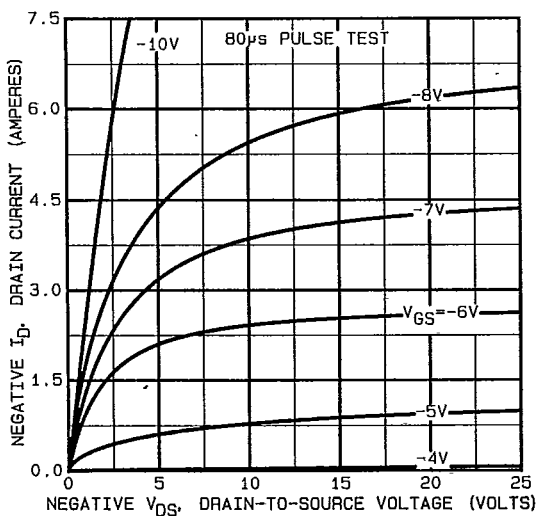


Fig. 1 — Typical Output Characteristics

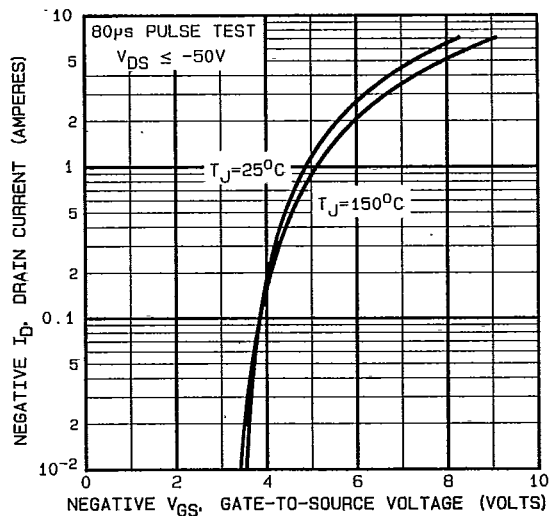


Fig. 2 — Typical Transfer Characteristics

IRFR9010, IRFR9012, IRFU9010, IRFU9012 Devices

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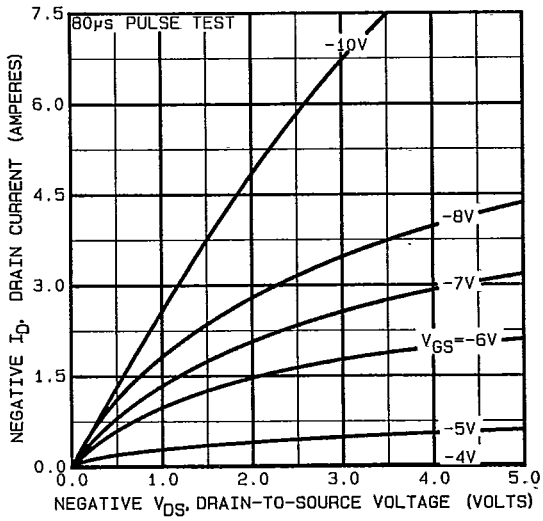


Fig. 3 — Typical Saturation Characteristics

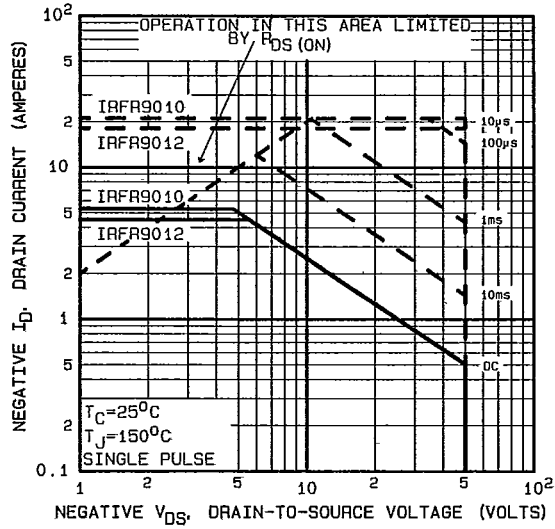


Fig. 4 — Maximum Safe Operating Area

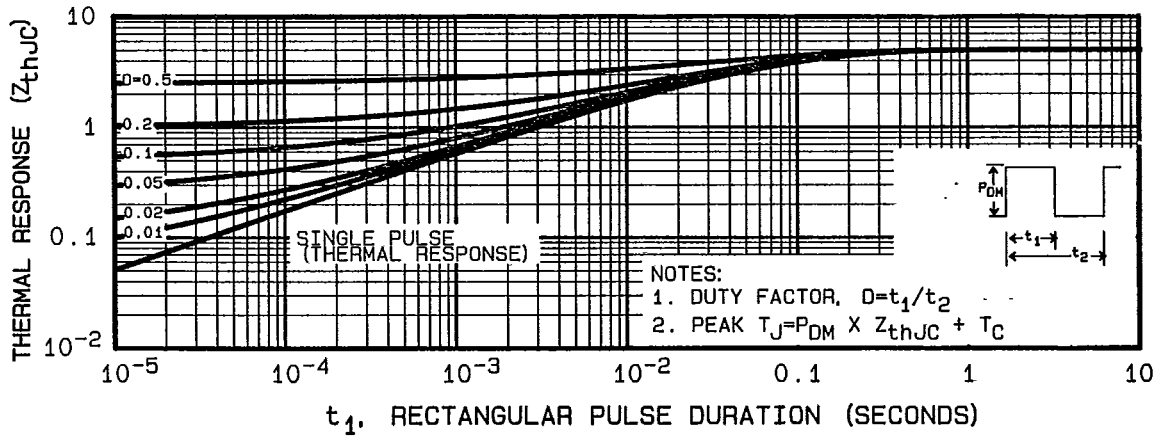


Fig. 5 — Maximum Effective Transient Thermal Impedance, Junction-to-Case Vs. Pulse Duration

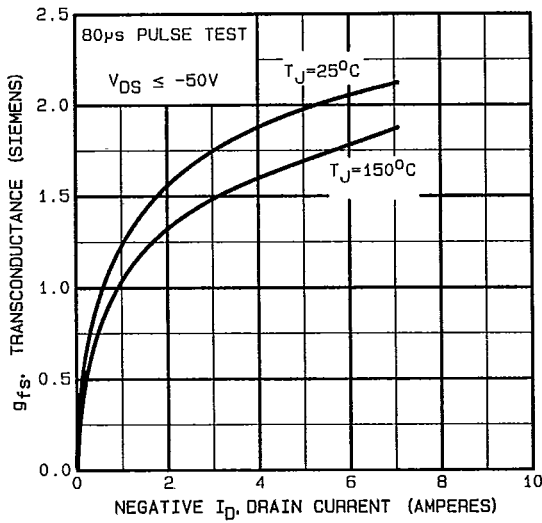


Fig. 6 — Typical Transconductance Vs. Drain Current

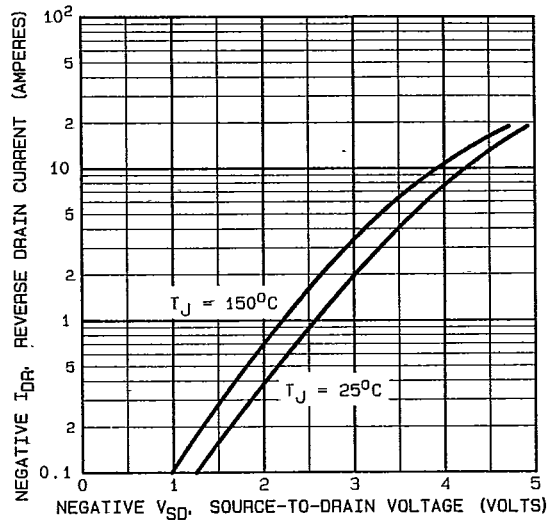


Fig. 7 — Typical Source-Drain Diode Forward Voltage

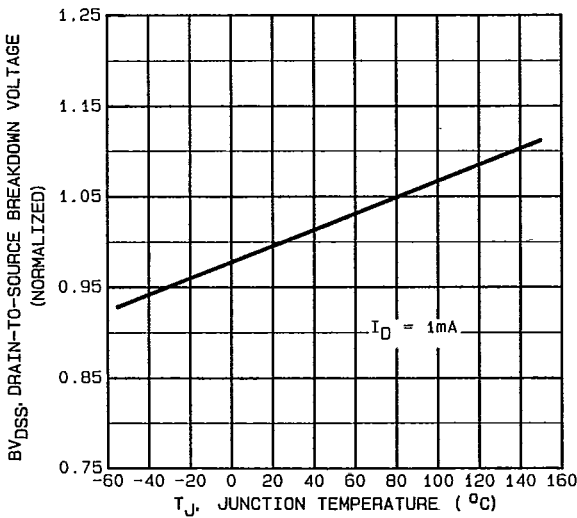


Fig. 8 — Breakdown Voltage Vs. Temperature

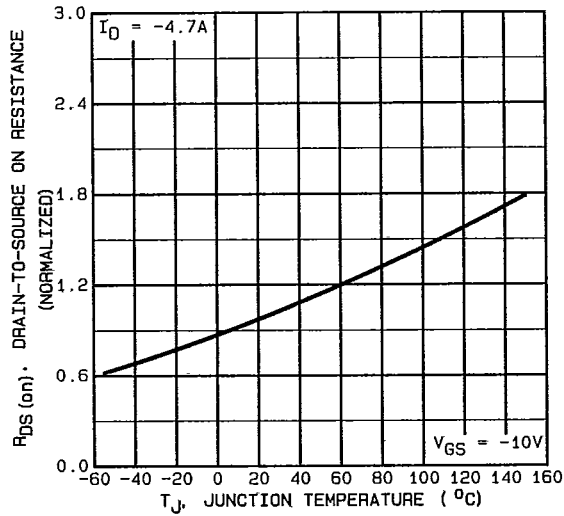


Fig. 9 — Normalized On-Resistance Vs. Temperature



IRFR9010, IRFR9012, IRFU9010, IRFU9012 Devices

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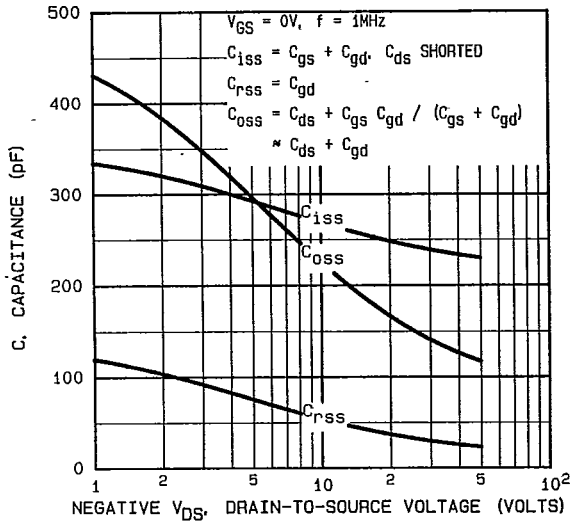


Fig. 10 — Typical Capacitance Vs. Drain-to-Source Voltage

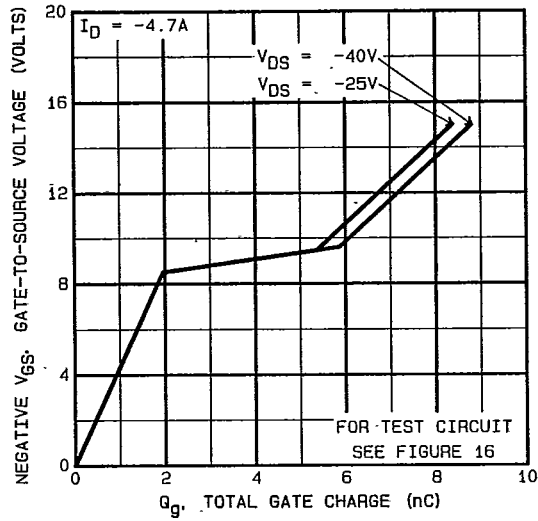


Fig. 11 — Typical Gate Charge Vs. Gate-to-Source Voltage

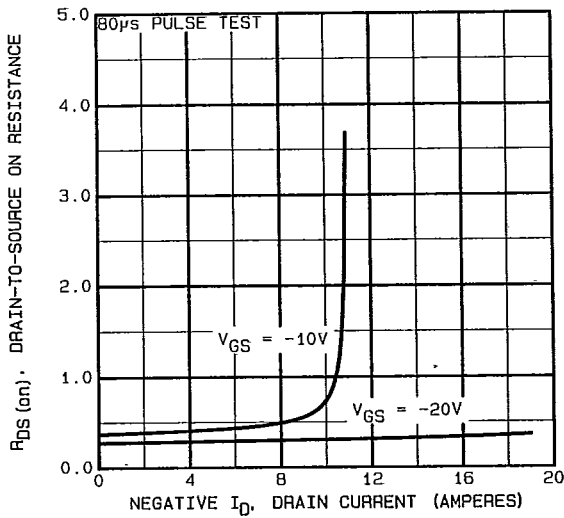


Fig. 12 — Typical On-Resistance Vs. Drain Current

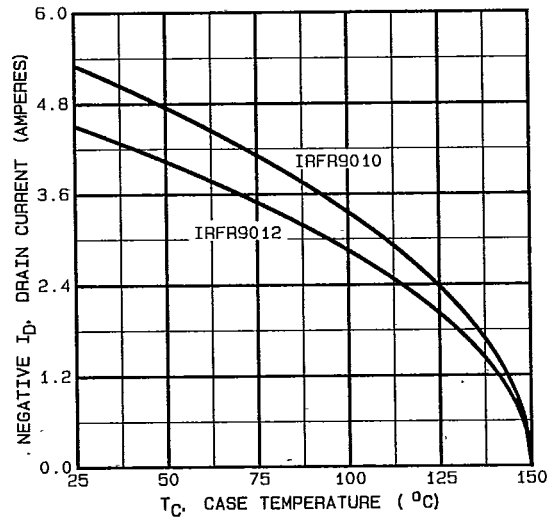


Fig. 13 — Maximum Drain Current Vs. Case Temperature

IRFR9010, IRFR9012, IRFU9010, IRFU9012 Devices

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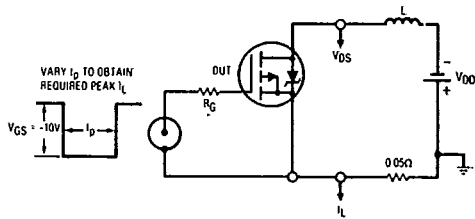


Fig. 14a — Unclamped Inductive Test Circuit

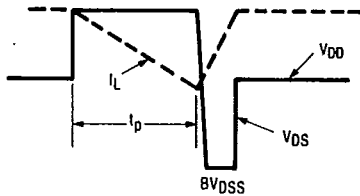


Fig. 14b — Unclamped Inductive Waveforms

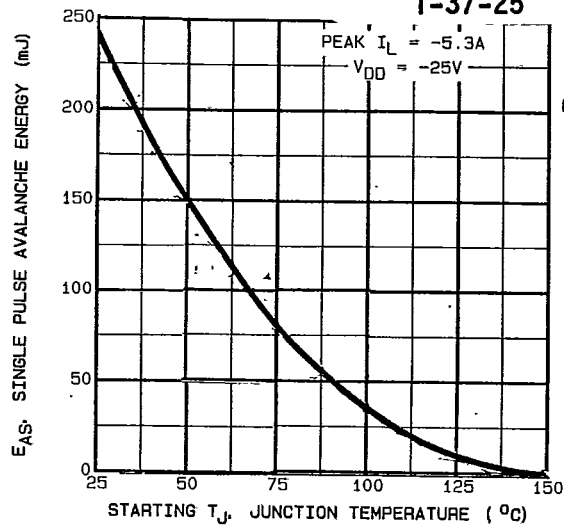


Fig. 14c — Maximum Avalanche Vs. Starting Junction Temperature

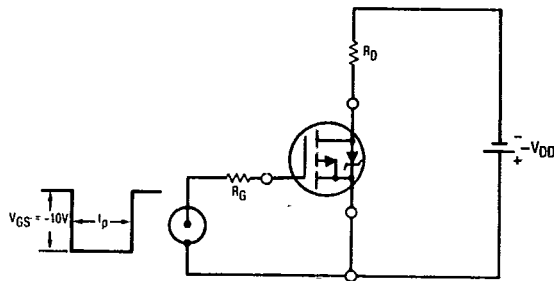
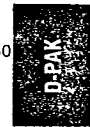


Fig. 15a — Switching Time Test Circuit

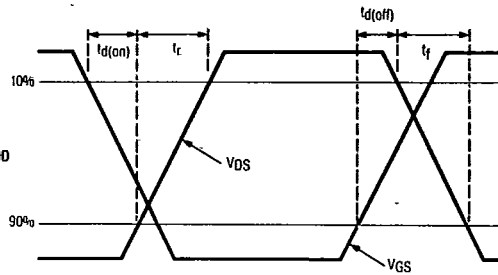


Fig. 15b — Switching Time Waveforms

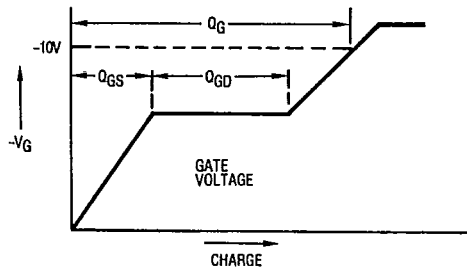


Fig. 16a — Basic Gate Charge Waveform

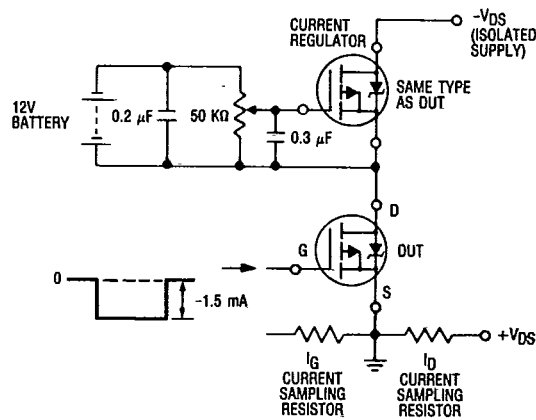


Fig. 16b — Gate Charge Test Circuit

IRFR9010, IRFR9012, IRFU9010, IRFU9012 Devices

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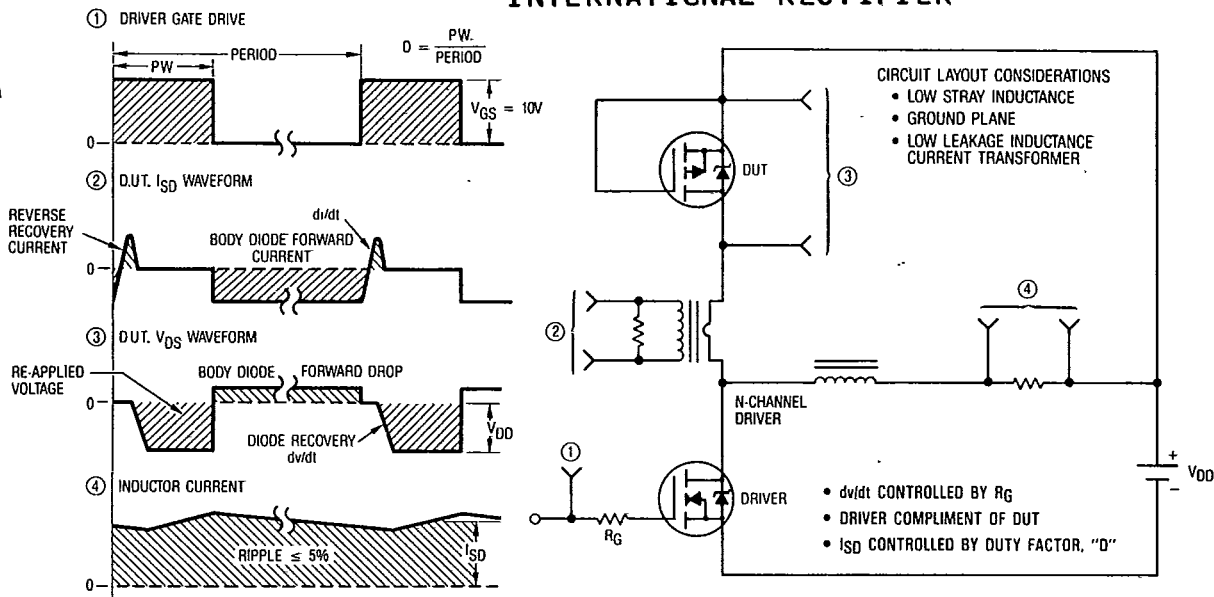


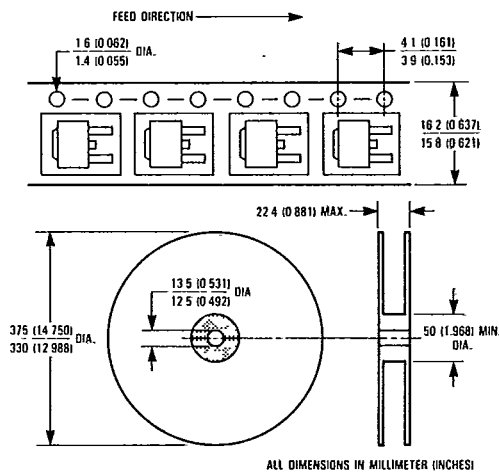
Fig. 17 — Peak Diode Recovery dv/dt Test Circuit

ORDERING INFORMATION

PACKAGING

IRFR Series — Tape and reel  
 when ordering, add TR after the part number  
 and the quantity  
 (order in multiples of 3,000 pieces).

Example: IRFR9010TR — 15,000 pieces





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- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
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